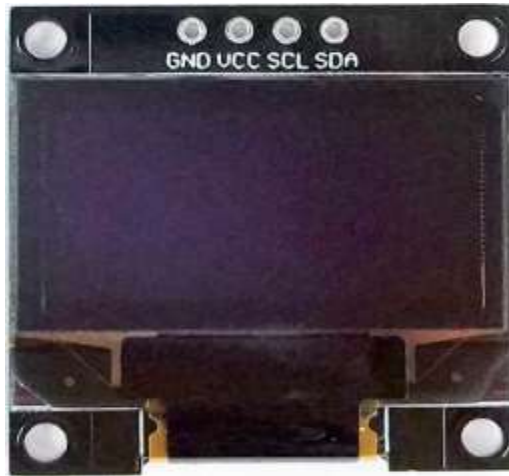




# SPECIFICATION OF MODULE

**MODULE NO: ZC-009601-0561**



**Customer Approval:**

**Accept**

**Reject**

<b>ZOYO FOCUS</b>	<b>SIGNATURE</b>	<b>DATE</b>
<b>PREPARED BY</b>	JYQ	2024.02.18
<b>CHECKED BY</b>	YG	2024.02.18
<b>APPROVED BY</b>		

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杭州中有触显智能科技

Hangzhou ZoYo Chuxian Intelligent Techonology



DISPLAY SELL

SKU.No.: DS10035

REV: A

PAGE: 2/2

NO: DSLM096I-128064

Sample Version	Doc. Version	DATE	DESCRIPTION	CHECKED BY
01	A	2024.02.18	First Release.	YG

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# 1 Basic specifications

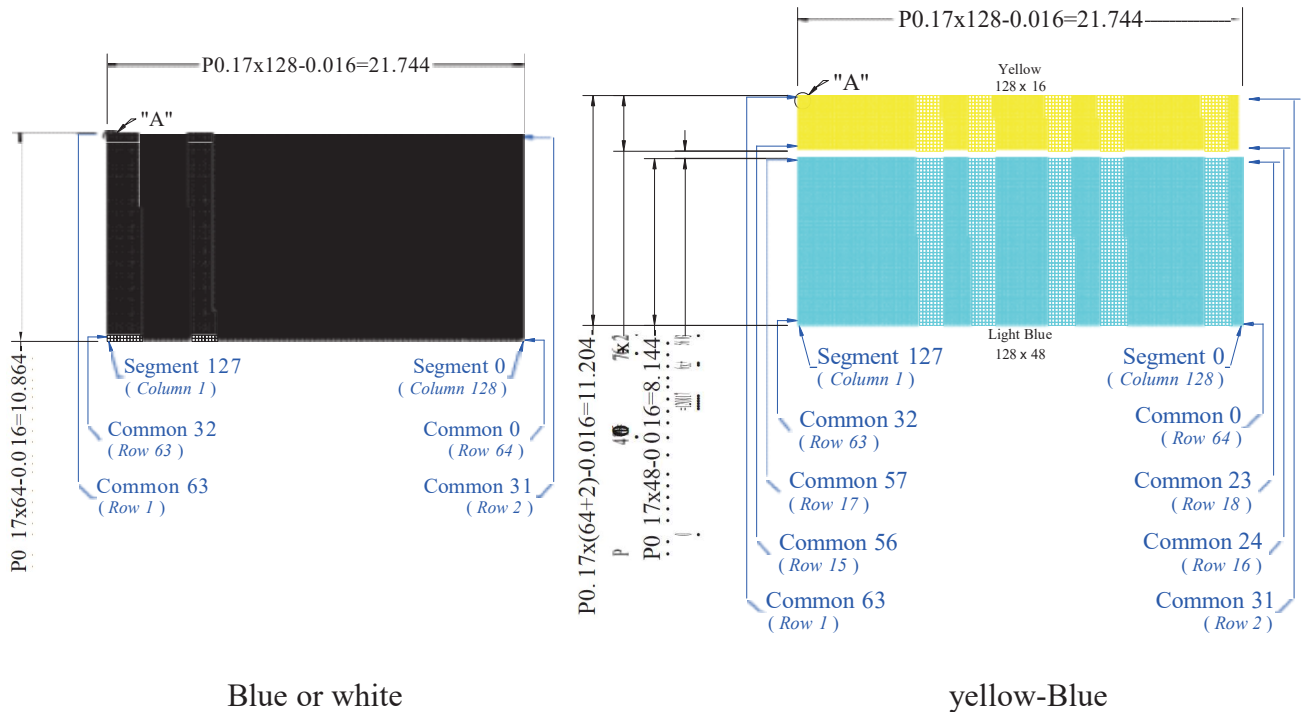
## 1.1 Display specifications

Item	specs
Display Mode	passive Matrix OLED&Blue,white,yellow-Blue
Interface	I2C
Drive Duty	1/64
Driver IC	ssD1306
shell	0.5T
Other	

## 1.2 Mechanical specifications

Item	specs	Unit	Remark
Outline Drawing	27.2.7(w)x27.2(H)3.0Max(T)	mm	
view Area	26.7(w)x19.26(H)	mm	
Active Area	21.744(w)x10.864(H)	mm	
Lattice	128dots x 64dots	--	
pixel pitch	0.17(w)x0.17(H)	mm	
pixel size	0.154(w)x0.154(H)	mm	

## 1.3 Active Area & pixel Construction



# 1.4 Mechanical Drawing

**Count drawing's modified record with customer**

VER. #1	DESCRIPTION THE FIRST ISSUE	DATE 2017-10-16
---------	-----------------------------	-----------------

Pin	Symbol
1	GND
2	VCC
3	SCL
4	SDA

Display Type	OLED
Logic IO Level	NEGATIVE TRANSMISSIVE 3.0V
Operation Temperature	-40°C TO +85°C
Storage Temperature	-45°C TO +90°C
Interface	IIC
Color	Blue,White,Yellow-Blue
Drive IC	SSDI306
All radii: without dimension	
Unspecified tolerance is	±0.2
ROHS request	Yes

	MODULE NO.	DESIGNED	CHECKED	VERIFIED	APPROVED	Glass No.	OLED MODULE	
	DAVIDE	2017-11-18					FILE NAME	
UNIT mm	SIZE A4	SCALE FIT						
Count Drawing								

## 1.5 pin Definition

Pin No.	Symbol	I/O	Function
1	GND	P	<i>Ground of Analog Circuit</i> This is an analog ground pin. It should be connected to VSS externally.
2	VCC	P	<i>Power Supply for Display Module Circuit</i> This is a voltage supply pin. It connected to external source. VCC=3.3V or 5V.
3	SCL	I	<i>Serial Clock Input Signal</i> The transmission of information in the bus is following a clock signal. Each transmission of data bit is taken place during a single clock period of this pin.
4	SDA	I	<i>Serial Data Input Signal</i> This pin acts as a communication channel. The input data through SDA are latched at the rising edge of SCLK in the sequence of MSB first and converted to 8-bit parallel data and handled at the rising edge of last serial clock.

### Note

Default address is 0x78.

---

## 2. Absolute Maximum Ratings

parameter	symbol	Min	Max	unit	Notes
power supply Voltage	V <sub>cc</sub>	2	6	V	1,2
power supply current	I <sub>cc</sub>	-	18	mA	1,2
Operating Temperature	Top	-30	70	°C	-
storage Temperature	Tstg	-40	80	°C	-

Note 1: All the above voltage are on the basis of “GND=0V”.

Note 2: when this module is used beyond the above absolute maximum

Ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to section 3. “Electrical characteristics”. If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

## 3. Electrical characteristics

### 3.1 Dc characteristics

characteristics	symbol	conditions	Min	Typ	Max	unit
supply Voltage	V <sub>cc</sub>	Ta=25°C	2.5	-	5.5	V
High Level Input	V <sub>IH</sub>	I <sub>out</sub> =100uA 3.3MHz	1.32	-	3.6	V
Low Level Input	V <sub>IL</sub>	I <sub>out</sub> =100uA 3.3MHz	0	-	0.7	V
supply current	I <sub>cc</sub>	Note1	-	7.3	9.1	mA
		Note2	-	12.3	15.4	mA
sleep Mode current	I <sub>cc, sleep</sub>		-	1	5	uA

Note1: V<sub>cc</sub>=3.7V, 50% Display Area Turn on;

Note2: V<sub>cc</sub>=3.7V, 100% Display Area Turn on.



### 3.2 Optics & Electrical Characteristics

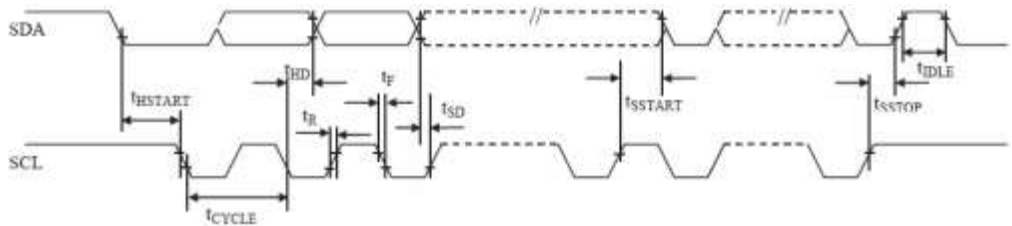
Characteristics	sYmbol	Conditions	Min	TYp	Max	Unit
Brightness	Lbr	with polarizer (Note 3)	80	100	-	Cd/m2
C.I.E.(white)	(X) (Y)	with polarizer	0.28 0.29	0.32 0.33	0.36 0.37	
C.I.E.(Blue)	(X) (Y)	with polarizer	0.12 0.22	0.16 0.26	0.20 0.30	
C.I.E.(Yellow)	(X) (Y)	with polarizer	0.44 0.46	0.48 0.50	0.52 0.54	
Dark Room Contrast	CR		-	>2000:1	-	
view Angle			>160	-	-	degree

\* Optical measurement taken at vDD =2.8v, vCC=9.0v, and software configuration follows “software Initial setting”.

### 3.3 I2C Interface Timing Characteristics:

Symbol	Description	Min	Max	Unit
$t_{\text{cycle}}$	Clock Cycle Time	2.5	-	us
$t_{\text{HSTART}}$	Start Condition Hold Time	0.6	-	us
$t_{\text{HD}}$	Data Hold Time (for “SDA <sub>OUT</sub> ” Pin)	0	-	ns
	Data Hold Time (for “SDA <sub>IN</sub> ” Pin)	300		
$t_{\text{SD}}$	Data Setup Time	100	-	ns
$t_{\text{SSTART}}$	Start Condition Setup Time (Only relevant for a repeated Start condition)	0.6	-	us
$t_{\text{SSTOP}}$	Stop Condition Setup Time	0.6	-	us
$t_{\text{R}}$	Rise Time for Data and Clock Pin		300	ns
$t_{\text{F}}$	Fall Time for Data and Clock Pin		300	ns
$t_{\text{IDLE}}$	Idle Time before a New Transmission can Start	1.3	-	us

\* ( $V_{\text{DD}} - V_{\text{SS}} = 1.65\text{V to } 3.3\text{V}$ ,  $T_{\text{a}} = 25^{\circ}\text{C}$ )



## 4.1 McU I2c Interface

The I2c communication interface consists of slave address bit SA0, I2c-bus data signal SDA(SDAOUT/D2 for output and SDAIN/D1 for input) and I2c-bus clock signal ScL (D0). Both the data and clock signals must be connected to pull-up resistors. /RES is used for the initialization of device.

### a) Slave address bit (SA0)

SSD1306 has to recognize the slave address before transmitting or receiving any information by the I2c-bus. The device will respond to the slave address following by the slave address bit(“SA0” bit) and the read/write select bit (“R/w#” bit) with the following byte format,

b7	b6	b5	b4	b3	b2	b1	b0
0	1	1	1	1	0	SA0	R/w

“SA0” bit provides an extension bit for the slave address. Either “0111100” or “0111101”, can be selected as the slave address of SSD1306. Dc pin acts as SA0 for slave address selection. “R/w” bit is used to determine the operation mode of the I2c-bus interface. R/w=1, it is in read mode. R/w=0, it is in write mode.

### b) I2c-bus data signal (SDA) SDA acts as a communication channel between the transmitter and the receiver. The data and the acknowledgement are sent through the SDA.

It should be noticed that the ITO track resistance and the pulled-up resistance at “SDA” pin becomes a voltage potential divider. As a result, the acknowledgement would not be possible to attain a valid logic 0 level in “SDA”.

“SDAIN” and “SDAOUT” are tied together and serve as SDA. The “SDAIN” pin must be connected to act as SDA. The “SDAOUT” pin may be disconnected. when “SDAOUT” pin is disconnected, the acknowledgement signal will be ignored in the I2c-bus.

### b) I2c-bus clock signal (ScL)

The transmission of information in the I2c-bus is following a clock signal, ScL. Each transmission of data bit is taken place during a single clock period of ScL.

### 4.1.1 I2c-bus write data

The I2c-bus interface gives access to write data and command into the device. please refer to the following Figure for the write mode of I2c-bus in chronological order.

---

## I2C-bus data format

Note: Co – Continuation bit

D/C# - Data / Command Selection bit

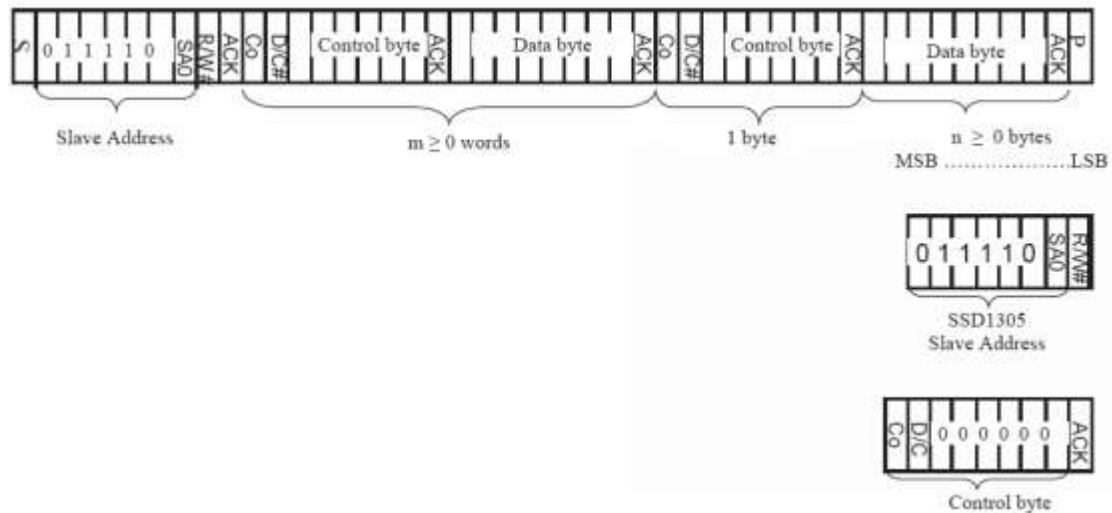
ACK – Acknowledgement

SA0 – Slave address bit

R/w# - Read/write Selection bit

S – Start Condition / P – Stop Condition

write mode



### 4.1.2 write mode for I2C

- 1) The master device initiates the data communication by a start condition. The definition of the start condition is shown in the following Figure (1). The start condition is established by pulling the SDA from HIGH to LOW while the SCL stays HIGH.
- 2) The slave address is following the start condition for recognition use. For the SSD1306, the slave address is either “b0111100” or “b0111101” by changing the SA0 to LOW or HIGH (DC pin acts as SA0).
- 3) The write mode is established by setting the R/wbit to logic “0”.
- 4) An acknowledgement signal will be generated after receiving one byte of data, including the slave address and the R/w bit. Please refer to the following Figure (2) for the graphical representation of the acknowledge signal. The acknowledge bit is defined as the SDA line is pulled down during the HIGH period of the acknowledgement related clock pulse.
- 5) After the transmission of the slave address, either the control byte or the data byte may be sent across the SDA. A control byte mainly consists of Co and A0 bits following by six “0” ‘s.
  - a. If the Co bit is set as logic “0”, the transmission of the following information will contain data bytes only.

- b. The Aobit determines the next data byte is acted as a command or a data. If the Aobit is set to logic “0”, it defines the following data byte as a command. If the Aobit is set to logic “1”, it defines the following data byte as a data which will be stored at the GDDRAM. The GDDRAM column address pointer will be increased by one automatically after each data write.
- 6) Acknowledge bit will be generated after receiving each control byte or data byte.
- 7) The write mode will be finished when a stop condition is applied. The stop condition is also defined in Figure (1). The stop condition is established by pulling the “SDA in” from LOW to HIGH while the “SCL” stays HIGH.

Figure (1): Definition of the Start and Stop Condition

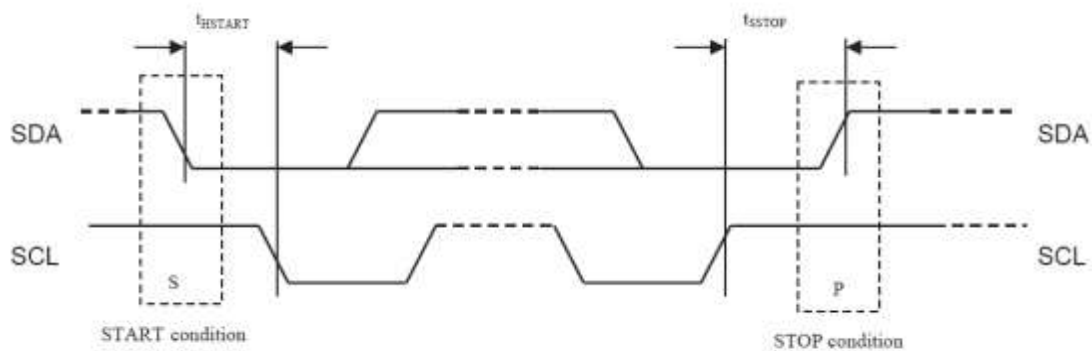
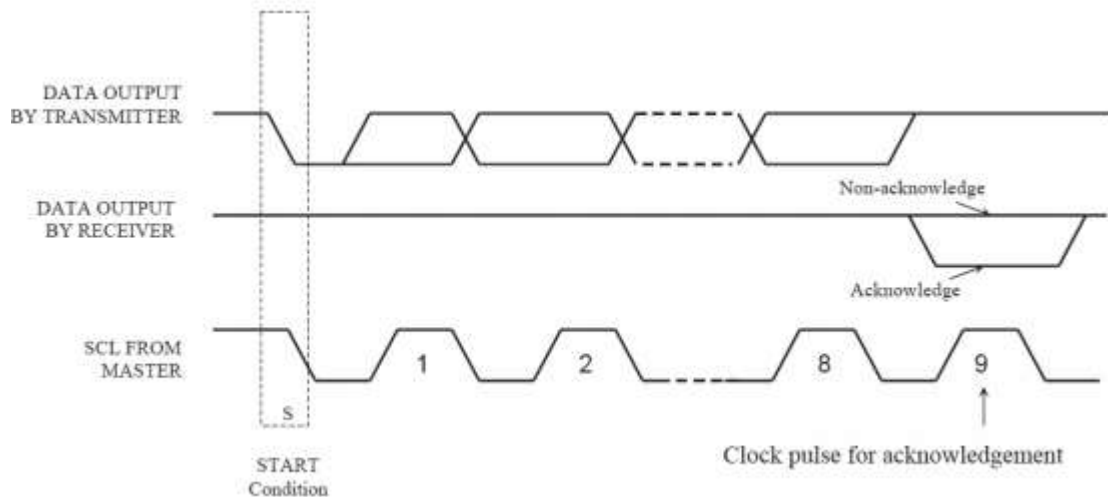


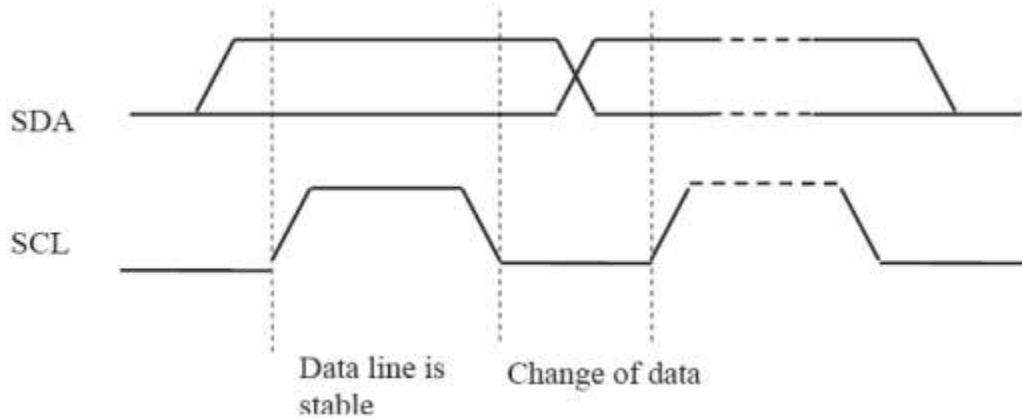
Figure (2): Definition of the acknowledgement condition



please be noted that the transmission of the data bit has some limitations.

1. The data bit, which is transmitted during each SCL pulse, must keep at a stable state within the “HIGH” period of the clock pulse. please refer to the Figure (3) for graphical representations. Except in start or stop conditions, the data line can be switched only when the SCL is LOW.
2. Both the data line (SDA) and the clock line (SCL) should be pulled up by external resistors.

Figure (3): Definition of the data transfer condition



## 4.2 Command Decoder

Refer to the Technical Manual for the SSD1306.

## 4.3 FR synchronization

Refer to the Technical Manual for the SSD1306.

## 4.4 Reset Circuit

when /RES input is low, the chip is initialized with the following status:

1. Display is OFF.
  2. 128x64 MUX Display Mode.
  3. Normal segment and display data column address and row address mapping (SEG0 mapped to address 00h and COM0 mapped to address 00h).
  4. Shift register data clear in serial interface.
  5. Display start line is set at display RAM address 0.
  6. Column address counter is set at 0.
  7. Normal scan direction of the COM outputs.
  8. Contrast control register is set at 7Fh.
  9. Normal display mode (Equivalent to A4h command).
-

## 5. Reliability

### 5.1 contents of Reliability Tests

Item	conditions		criteria
High Temperature operation	85°C	TBD	The operational Functions work
Low Temperature operation	-40°C	TBD	
High Temperature storage	90°C	TBD	
Low Temperature storage	-45°C	TBD	
High Temperature/Humidity operation	60°C	TBD	
Thermal shock	-40°C ⇌ 90°C	TBD	

\* The samples used for the above tests do not include polarizer.

\* No moisture condensation is observed during tests.

### 5.2 Life time

End of lifetime is specified as 50% of initial brightness.

parameter	Min	Max	Unit	condition	Notes
operating Life Time	50,000	-	Hrs	80 cd/m <sup>2</sup> ,50%checkerboard	6
storage Life Time	200,000	-	Hrs	Ta=25 °C,50%RH	-

Note 6: The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.

### 5.3 Failure check standard

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23+/-5°C; 55+/-15%RH.

## 6. outgoing Quality control specifications

### 6.1 Environment Required

customer,s test & measurement are required to be conducted under the following conditions:

Temperature:	23+/-5°C
Humidity:	55+/-15%RH
Fluorescent Lamp:	30w
Distance between the panel & Lamp:	>=50 cm
Distance between the panel & Eyes of the Inspector	>=30 cm
Finger glove (or finger cover) must be worn by the inspector.	
Inspection table or jig must be anti-electrostatic.	

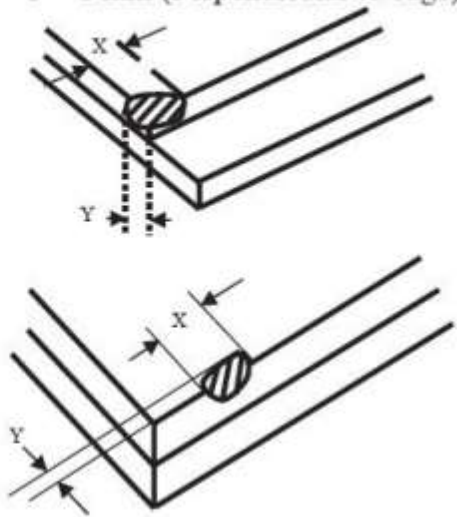
### 6.2 sampling plan

Level II, Normal Inspection, single sampling,MIL-sTD-105E

### 6.3 criteria & Acceptable Quality Level

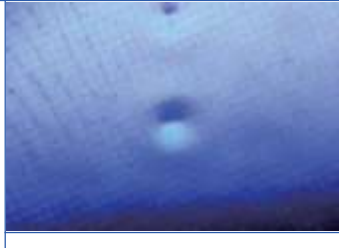
partition	AQL	Definition
Major	0.65	Defects in pattern check (Display on)
Minor	1.0	Defects in cosmetic check (Display off)

#### 6.3.1 cosmetic check (Display off) in Non-Active Area

Check Item	Classification	Criteria
Panel General Chipping	Minor	<p>X &gt; 6 mm (Along with Edge) Y &gt; 1 mm (Perpendicular to edge)</p> 

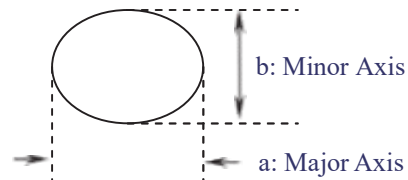
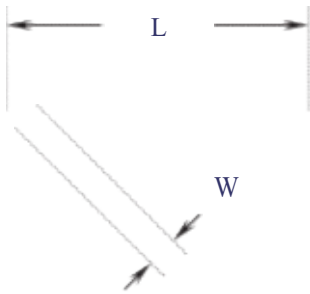


### 6.3.2 Cosmetic Check (Display Off) inActive Area


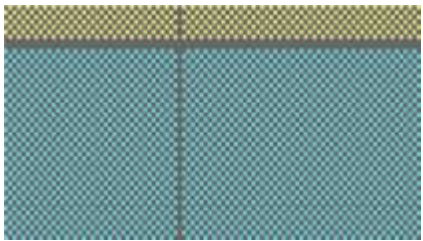
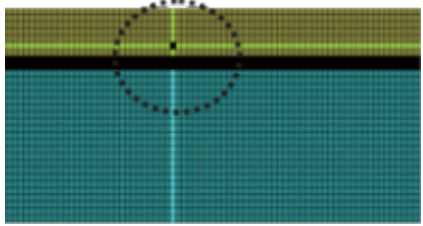
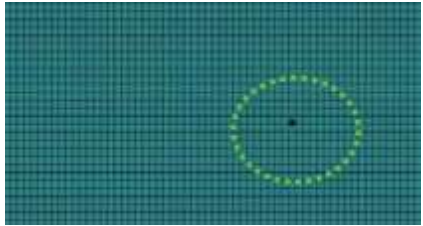
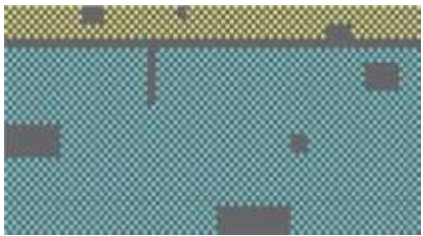
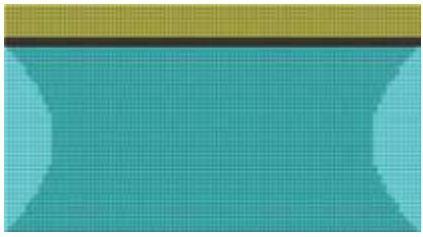
Check Item	Classification	Criteria
Any Dirt & Scratch on Polarizer's Protective Film	Acceptable	Ignore for not Affect the Polarizer
Scratches, Fiber, Line-Shape Defect (On Polarizer)	Minor	$W \leq 0.1$ Ignore $W > 0.1, L \leq 2$ $n \leq 1$ $L > 2$ $n = 0$
Dirt, Black Spot, Foreign Material, (On Polarizer)	Minor	$\Phi \leq 0.1$ Ignore $0.1 < \Phi \leq 0.25$ $n \leq 1$ $0.25 < \Phi$ $n = 0$
Dent, Bubbles, White spot (Any Transparent Spot on Polarizer)	Minor	$\Phi \leq 0.5$ → Ignore if no Influence on Display $0.5 < \Phi$ $n = 0$
		
Fingerprint, Flow Mark (On Polarizer)	Minor	Not Allowable

\* Protective film should not be tear off when cosmetic check.

\*\* Definition of W & L &  $\Phi$  (Unit: mm):  $\Phi = (a + b) / 2$



6.3.3 pattern Check (Display On) in Active Area

Check Item	Classification	Criteria
No Display	Major	
Flicker	Major	Not Allowable
Missing Line	Major	
Pixel Short	Major	
Darker Pixel	Major	
Wrong Display	Major	
Un-uniform	Major	

## 7. precautions when using These OLED Display Modules

### 7.1 Handling precautions

- 1) since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
  - 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
  - 3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
  - 4) The polarizer covering the surface of the OLED display module is soft and easily scratched. please be careful when handling the OLED display module.
  - 5) when the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
    - \* scotch Mending Tape No. 810 or an equivalentNever try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer

    - \* water
    - \* ketone
    - \* Aromatic solvents
  - 6) when installing the OLED display module, be careful not to apply twisting stress or deflection stress to the OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.
  - 7) Do not apply stress to the LSI chips and the surrounding molded sections.
  - 8) Do not disassemble nor modify the OLED display module.
  - 9) Do not apply input signals while the logic power is off.
  - 10) pay sufficient attention to the working environments when handling OLED display modules to prevent occurrence of element breakage accidents by static electricity.
    - \* Be sure to make human body grounding when handling OLED display modules.
    - \* Be sure to ground tools to use or assembly such as soldering irons.
    - \* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
    - \* protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.
  - 11) protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display
-

panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).

- 12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

## 7.2 Storage precautions

- 1) when storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps.and, also, avoiding high temperature and high humidity environment or low temperature (less than 0 ° C) environments. (we recommend you to store these modules in the packaged state when they were shipped from ZOYO.)

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

- 2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

## 7.3 Designing precautions

- 1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- 3) we recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- 4) pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- 5) As for EMI, take necessary measures on the equipment side basically.
- 6) when fastening the OLED display module, fasten the external plastic housing section.
- 7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.
- 8) The electric potential to be connected to the rear face of the IC chip should be as follows: SSD1331

\* Connection (contact) to any other potential than the above may lead to rupture of the IC.

## 7.4 precautions when disposing of the OLED display modules

- 1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

## 7.5 Other precautions

- 1) when an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur. Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
  - 2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.
    - \* pins and electrodes
    - \* pattern layout such as the FpC
  - 3) with this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.
    - \* Design the product and installation method so that the OLED driver may be shielded from light in actual usage.
    - \* Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.
  - 4) Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
  - 5) we recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
-

## 8. Appendixes

### 8.1 Display-module software Initial setting

```
Write_Command(0xAE); //display off
Write_Command(0x20); //Set Memory Addressing Mode<00FF>
Write_Command(0x10); //Addressing Modee
Write_Command(0xb0); //Set Page Start Address for Page Addressing Mode,0-7
Write_Command(0xc8); //Set COM Output Scan Direction
Write_Command(0x00); //---set low column address
Write_Command(0x10); //---set high column address
Write_Command(0x40); //--set start line address
Write_Command(0x81); //--set contrast control register
Write_Command(0xaf);
Write_Command(0xa1); //--set segment re-map 0 to 127
Write_Command(0xa6); //--set normal display
Write_Command(0xa8); //--set multiplex ratio(1 to 64)
Write_Command(0x3F);
Write_Command(0xa4); //0xa4,Output follows RAM content;0xa5,Output ignores RAM content
Write_Command(0xd3); //-set display offset
Write_Command(0x00); //-not offset
Write_Command(0xd5); //--set display clock divide ratio/oscillator frequency
Write_Command(0xf0); //--set divide ratio
Write_Command(0xd9); //--set pre-charge period
Write_Command(0x22);
Write_Command(0xda); //--set com pins hardware configuration
Write_Command(0x12);
Write_Command(0xdb); //--set vcomh
Write_Command(0x20); //0x20,0.77xVcc
Write_Command(0x8d); //--set DC-DC enable
Write_Command(0x14);
Write_Command(0xaf); //--turn on oled panel
```

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